



### **General Description**

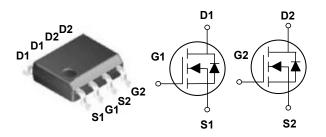
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub>
20 V	27 mΩ	6.9 A

### **Features**

- $R_{DS(ON)} \leq 27 m\Omega @V_{GS} = 4.5V$
- · Improved dv/dt Capability
- Fast Switching
- · Green Device Available

### SOP-8 Pin Configuration



### **Applications**

- Notebook
- · Load Switch
- · Hand-Held Instruments

Absolute Maxim	bsolute Maximum Ratings T <sub>A</sub> =25°C unless otherwise noted						
Symbol	Parameter	Rating	Units				
$V_{DS}$	Drain-Source Voltage	20	V				
$V_{GS}$	Gate-Source Voltage	±12	V				
I <sub>D</sub>	Drain Current - Continuous	6.9	Α				
I <sub>DM</sub>	Drain Current - Pulsed (NOTE 1)	27	Α				
$P_{D}$	Power Dissipation (NOTE 1)	1.98	W				
$T_J$	Operating Junction Temperature Range	-50 to 150	°C				
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C				
Marking Code		NB027					

Thermal Characteristics					
Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		63	°C/W	





### Electrical Characteristics (T<sub>.1</sub>=25°C, unless otherwise noted)

#### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	20			V
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =20V , $V_{GS}$ =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ =±12V , $V_{DS}$ =0V			±100	nA

### On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		$V_{GS}$ =4.5V , $I_D$ =5A			27	
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}$ =2.5V , $I_D$ =4.7A			35	mΩ
		V <sub>GS</sub> =1.8V , I <sub>D</sub> =4.3A			57	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	0.4		1.0	V

### **Dynamic and switching Characteristics (NOTE 3)**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}$ =10V , $V_{GEN}$ =5V , $R_{GEN}$ =1 $\Omega$ , $I_D$ =4A		10		
T <sub>r</sub>	Rise Time			20		nS
$T_{d(off)}$	Turn-Off Delay Time			32		
$T_f$	Fall Time			12		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , F=1MHz		700		
C <sub>oss</sub>	Output Capacitance			120		pF
$C_{rss}$	Reverse Transfer Capacitance			105		

## **Drain-Source Diode Characteristics and Ratings**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$V_{SD}$	Diode Forward Voltage (NOTE 2)	$V_{GS}$ =0V , $I_{S}$ =4A			1.2	V

#### NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 3. Guaranteed by design, not subject to production testing.





### **Characteristics Curves**

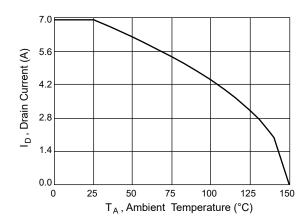


Fig.1 Drain Current

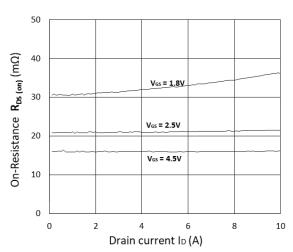


Fig.3  $R_{DS(on)}$  VS.  $I_D$ 

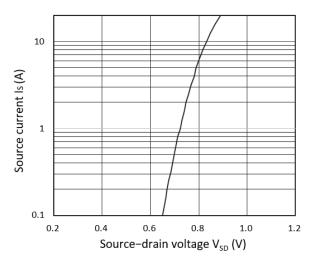


Fig.5 I<sub>S</sub> VS. V<sub>SD</sub>

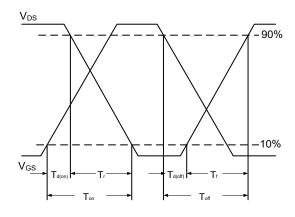


Fig.2 Switching Time Waveform

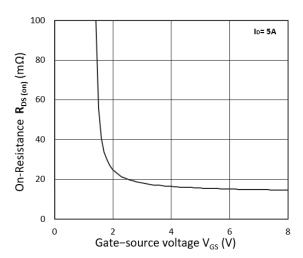


Fig.4 R<sub>DS(on)</sub> VS. V<sub>GS</sub>

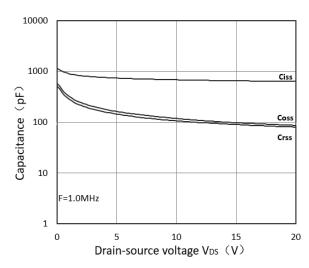
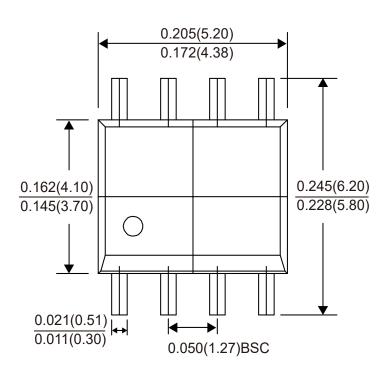


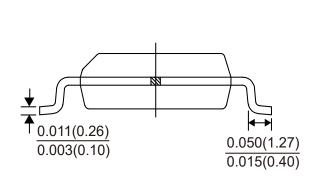
Fig.6 Capacitance Characteristics

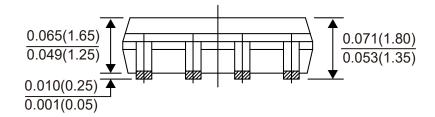




## **Package Outline Dimensions**







**SOP-8**Dimensions in inches and (millimeters)





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